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Vishay/Siliconix SI4056DY-T1-GE3

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Si4056DY

RoHS

COMPLIANT

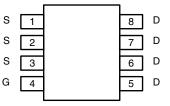
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see

N-Channel 100 V (D-S) MOSFET

PRODUCT SUMMARY					
V _{DS} (V)	R _{DS(on)} (Ω) Max.	I _D (A) ^a	Q _g (Typ.)		
	0.023 at V _{GS} = 10 V	11.1			
100	0.024 at V _{GS} = 7.5 V	10.8	9.7 nC		
	0.031 at V _{GS} = 4.5 V	9.5			





Top View

Ordering Information:

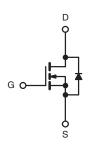
Si4056DY-T1-GE3 (Lead (Pb)-free and Halogen-free)

FEATURES

- TrenchFET[®] Power MOSFET
- 100 % Rg and UIS Tested
- Material categorization: For definitions of compliance please www.vishay.com/doc?99912

APPLICATIONS

- DC/DC Primary Side Switch
- Telecom/Server
- Industrial
- Synchronous Rectification



N-Channel MOSFET

Parameter		Symbol	Limit	Unit
Drain-Source Voltage		V _{DS}	100	V
Gate-Source Voltage		V _{GS}	± 20	V
	T _C = 25 °C		11.1	
Continuous Drain Current (T. 150 °C)	T _C = 70 °C	1 . Г	8.8	
Continuous Drain Current ($T_J = 150 \ ^{\circ}C$)	T _A = 25 °C		7.3 ^{b, c}	
	T _A = 70 °C	1 F	5.8 ^{b, c}	
Pulsed Drain Current (t = 300 µs)		I _{DM}	70	A
	T _C = 25 °C		5.1	
Continuous Source-Drain Diode Current	T _A = 25 °C	I _S	2.2 ^{b, c}	
Single Pulse Avalanche Current	1 0.1 ml l	I _{AS}	15	
Avalanche Energy L = 0.1 mH		E _{AS}	11.2	mJ
	T _C = 25 °C		5.7	
Mariana Davian Diasia stian	T _C = 70 °C	1 5 6	3.6	
Maximum Power Dissipation	T _A = 25 °C	P _D	2.5 ^{b, c}	W
	T _A = 70 °C	1	1.6 ^{b, c}	
Operating Junction and Storage Temperature Range		T _J , T _{stg}	- 55 to 150	°C

THERMAL RESISTANCE RATINGS						
Parameter		Symbol	Typical	Maximum	Unit	
Maximum Junction-to-Ambient ^{b, d}	t ≤ 10 s	R _{thJA}	35	50	°C/W	
Maximum Junction-to-Foot (Drain)	Steady State	R _{thJF}	18	22	0/10	

Notes: a. Based on T_C = 25 °C.

b. Surface mounted on 1" x 1" FR4 board.

c. t = 10 s.

d. Maximum under steady state conditions is 85 °C/W.

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SPECIFICATIONS (T _J = 25 °C, unless otherwise noted)							
Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit	
Static							
Drain-Source Breakdown Voltage	V _{DS}	$V_{GS} = 0 V, I_D = 250 \mu A$	100			V	
V _{DS} Temperature Coefficient	$\Delta V_{DS}/T_J$	- Ι _D = 250 μΑ		67		mV/°C	
V _{GS(th)} Temperature Coefficient	$\Delta V_{GS(th)}/T_J$	η η μα		- 5			
Gate-Source Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}$, $I_D = 250 \ \mu A$	1.5		2.8	V	
Gate-Source Leakage	I _{GSS}	$V_{DS} = 0 V, V_{GS} = \pm 20 V$			± 100	nA	
Zara Cata Valtaga Drain Current		V _{DS} = 100 V, V _{GS} = 0 V	1		1		
Zero Gate Voltage Drain Current	IDSS	$V_{DS} = 100 \text{ V}, \text{ V}_{GS} = 0 \text{ V}, \text{ T}_{J} = 55 ^{\circ}\text{C}$			10	- μΑ	
On-State Drain Current ^a	I _{D(on)}	$V_{DS} \ge 5$ V, V_{GS} = 10 V	30			А	
		V _{GS} = 10 V, I _D = 15 A		0.017	0.023	Ω	
Drain-Source On-State Resistance ^a	R _{DS(on)}	V _{GS} = 7.5 V, I _D = 12 A		0.018	0.024		
		V _{GS} = 4.5 V, I _D = 10 A		0.022	0.031		
Forward Transconductance ^a	9 _{fs}	V _{DS} = 15 V, I _D = 15 A		26		S	
Dynamic ^b		1	1	1	1		
Input Capacitance	C _{iss}			900		pF	
Output Capacitance	C _{oss}	V _{DS} = 50 V, V _{GS} = 0 V, f = 1 MHz		340			
Reverse Transfer Capacitance	C _{rss}			31			
Total Gate Charge		$V_{DS} = 50 \text{ V}, V_{GS} = 10 \text{ V}, I_{D} = 10 \text{ A}$		19.6	29.5		
	Q _g		9.7	15	1		
Gate-Source Charge	Q _{gs}	$V_{DS} = 50 \text{ V}, V_{GS} = 4.5 \text{ V}, I_{D} = 10 \text{ A}$		2.8		nC	
Gate-Drain Charge	Q _{gd}			4.3			
Output Charge	Q _{oss}	$V_{DS} = 50 \text{ V}, V_{GS} = 0 \text{ V}$		26.2	40		
Gate Resistance	Rg	f = 1 MHz	0.2	0.85	1.7	Ω	
Turn-On Delay Time	t _{d(on)}			13	26		
Rise Time	t _r	V_{DD} = 50 V, R_L = 5 Ω		14	28	-	
Turn-Off Delay Time	t _{d(off)}	$\text{I}_\text{D}\cong$ 10 A, V_GEN = 7.5 V, R_g = 1 Ω		19	38		
Fall Time	t _f			10	20		
Turn-On Delay Time	t _{d(on)}			11	22	ns	
Rise Time	t _r	V_{DD} = 50 V, R_L = 5 Ω		10	20	-	
Turn-Off Delay Time	t _{d(off)}	$I_D \cong 10 \text{ A}, V_{\text{GEN}} = 10 \text{ V}, \text{ R}_g = 1 \Omega$		20	40		
Fall Time	t _f	1		9	18		
Drain-Source Body Diode Characteristics							
Continuous Source-Drain Diode Current	۱ _S	T _C = 25 °C			5.1		
Pulse Diode Forward Current ^a	I _{SM}			1	70	A	
Body Diode Voltage	V _{SD}	I _S = 4 A		0.77	1.1	V	
Body Diode Reverse Recovery Time	t _{rr}	-		34	65	ns	
Body Diode Reverse Recovery Charge	Q _{rr}	-		34	65	nC	
Reverse Recovery Fall Time	t _a	I _F = 5 A, di/dt = 100 A/μs, T _J = 25 °C		20		ns	
Reverse Recovery Rise Time	t _b	1		14			

Notes:

a. Pulse test; pulse width \leq 300 µs, duty cycle \leq 2 %

b. Guaranteed by design, not subject to production testing.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

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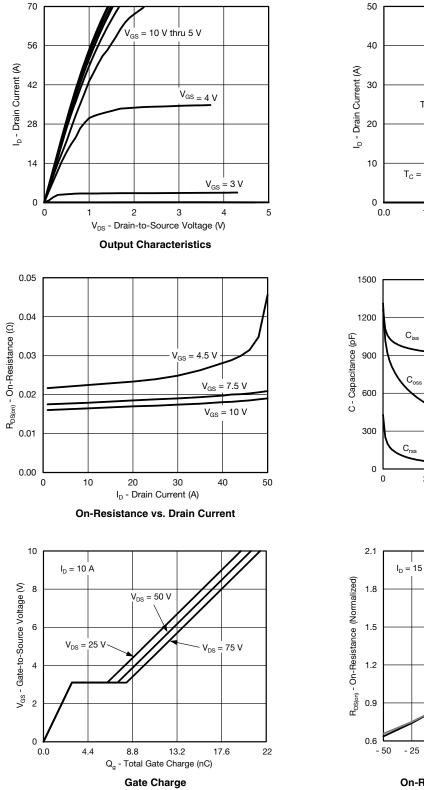


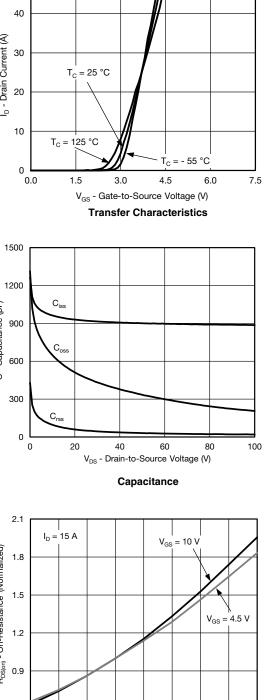


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TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)





T_J - Junction Temperature (°C) On-Resistance vs. Junction Temperature

75

100

125

50

0

25

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150

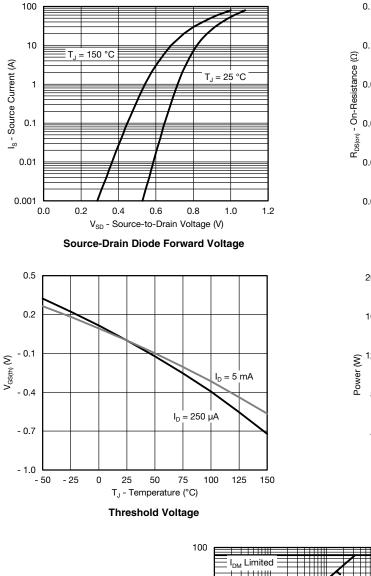


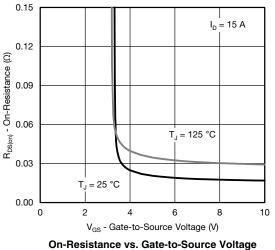
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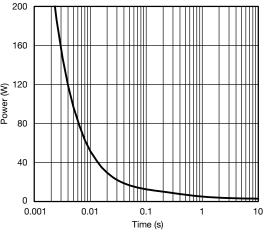


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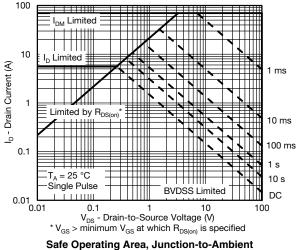
TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)







Single Pulse Power, Junction-to-Ambient



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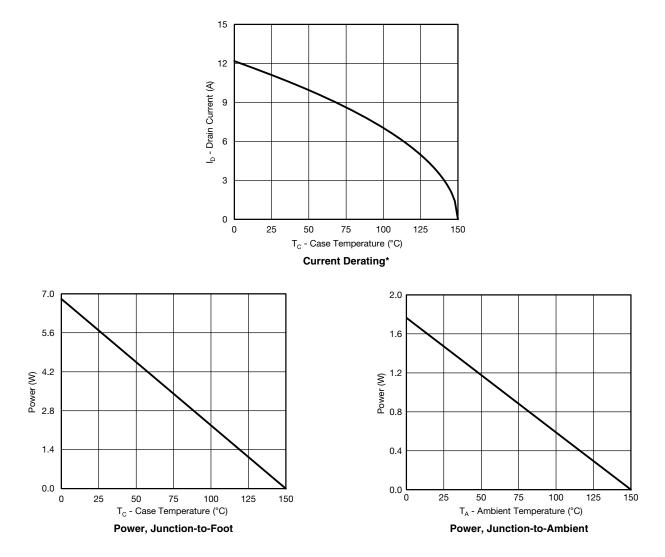




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TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



* The power dissipation P_D is based on $T_{J(max.)} = 150$ °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.

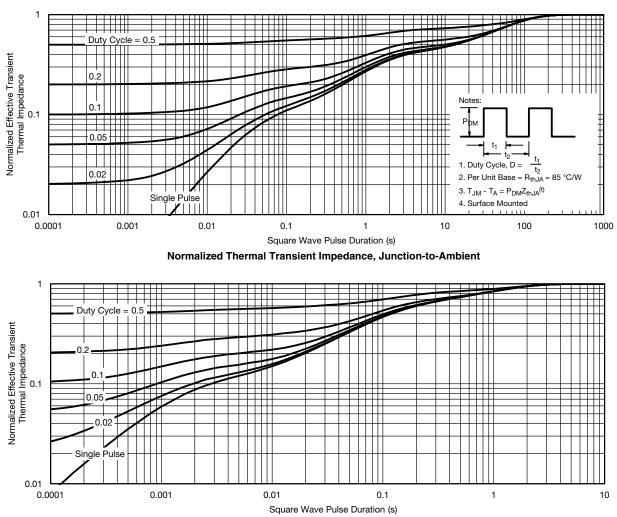


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TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



Normalized Thermal Transient Impedance, Junction-to-Foot

Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package/tape drawings, part marking, and reliability data, see www.vishay.com/ppg?62662.

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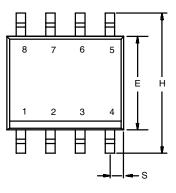


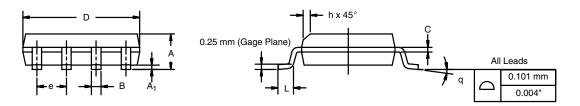


Package Information

Vishay Siliconix

SOIC (NARROW): 8-LEAD JEDEC Part Number: MS-012





	MILLIM	IETERS	INCHES			
DIM	Min	Max	Min	Мах		
A	1.35	1.75	0.053	0.069		
A ₁	0.10	0.20	0.004	0.008		
В	0.35	0.51	0.014	0.020		
С	0.19	0.25	0.0075	0.010		
D	4.80	5.00	0.189	0.196		
E	3.80	4.00	0.150	0.157		
е	1.27	BSC	0.050	0.050 BSC		
Н	5.80	6.20	0.228	0.244		
h	0.25	0.50	0.010	0.020		
L	0.50	0.93	0.020	0.037		
q	0°	8°	0°	8°		
S	0.44	0.64	0.018	0.026		
ECN: C-06527-Rev. I, 11-Sep-06 DWG: 5498						

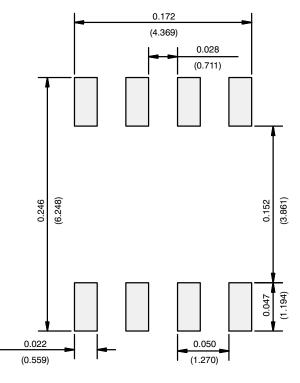


Application Note 826

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RECOMMENDED MINIMUM PADS FOR SO-8



Recommended Minimum Pads Dimensions in Inches/(mm)

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